

Phrozen Resin User Guide

Engineering Resin: FR940, Gray

Outline

Before printing the perfect object, it is important to first understand the material limitations we are handling and how it can be successfully printed under various conditions. With this in mind, Phrozen provides the following design suggestions to help you better understand the properties of each material and how you can best utilize them to bring your wildest creation to life.

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Section 1 TDS

General Properties	Norm	Typical values	
Appearance	-	Gray	
Viscosity, 30	Cone/Plate Rheometer ¹	180–285 mPas	
Density (liquid resin)	ASTM D4052-18a	1.14 g/cm³	
Tensile Properties	Norm	Typical value	S (UV post-cured)
E Modulus	ASTM D638	1812	2 MPa
Ultimate Tensile Strength	ASTM D638	28.5	МРа
Elongation at Break	ASTM D638	3.8 %	
Impact Properties	Norm	Typical values (UV post-cured)	
Notched Izod (Machined), 23 °C	ASTM D256	30.7 J/m	
Thermal Properties	Norm	Туріса	l values
		UV post-cured	UV +Thermal
HDT at 0.45 MPa	ASTM D648	59.8 °C	82.8 °C
Hardness	Norm	Typical values (UV post-cured)	
Shore D	ASTM D2240	75-80D	
Flammability	Norm	Typical values	
V-0 Burning stops within 10 seconds on a vertical specimen; drips of particles are allowed as long as they are not inflamed.	UL94 V-0	3.0-3.3mm	

*Except for the UL Test, which is printed on the Sonic Mini 4K, all other testing specimens are printed using Phrozen Sonic Mighty 8K or Sonic Mini 8K, and post-cured using Phrozen Cure & Wash. * After 60 minutes of post-curing, heat to 80°C for two more hours.

* Increasing curing time can improve mechanical properties but also increase the risk of deformation.

Specimens are printed unless stated otherwise. The information in this TDS, including product recommendations, is based on our current knowledge and experience. Descriptions, drawings, photographs, data, proportions, weights, etc. provided may change without notice and do not establish the product's contractual quality. Request the relevant MSDS from your supplier or contact Phrozen Tech Co., Ltd at <u>sales@phrozen3d.com</u>



UL Blue Card Certification

IEC and ISC	O Test Methods	Test Me		Uni		Thk (mm)	Value
		c	2023 UL Solutions			1 10/00/0	CERTIFIED TO EQUIREMENTS
Report Date: Last Revised:							
	materials used in the components and par						
	object with no exposure to light. Use post- same wavelength to cure for 30 minutes.	uring equipment (Phroz	en Cure & Wash/Phroz	zen Cure/ Phrozer	Mega Cure) or ot	her post-curing la	imps with the
(#)	- Soak object in Phrozen Wash with 95% alo			1		ly use compresse	ed air to dry the
Limited prop	perties and ratings assigned to samples produ	ced by the Additive Mai ameters and build strate				parameters and	build strategy.
	For use with printer: Phrozen	Sonic Mini 4K					
	Post Processing Method: Please se	ee footnote (#)					
	Build Plane: Horizonta	al & Vertical	Layer Thickness (mm): 0.05-0.1			0.1	
	Processing Parameters						
High-Voltage Arc Tracking Rate (HVTR): - Dimensional Change (%): -): -	High Volt, Low Current Arc Resis (D495): -				
			Surface Resistivity (10 ^x ohms/square): -				
	Dielectric Strength (kV/mm)	ic -	Volume Resistivity (10 ^x ohm-cm): -				
	Comparative Tracking Index (CTI)	i: -	Inclined	Plane Trackin	g (IPT) kV: -		
GY	3.0-3.3	V-0	-	•	50	50	50
Colo	r <u>(mm)</u>	<u>Flame</u> <u>Class</u>	HWI	HAL	Elec	Imp	RTI Str
Process Ca	ategory: VAT Polymerization - Liquid C hished as Liquid))		RTI	RTI	OT:
3rd FI 287 Niupu Rd Zhongpu VIg Xiangshan District, Hsinchu 300059 TW Phrozen-FR940 (#)							
	EN TECH CO LTD						
Guide Information View Certificate of Compliance							
Plastics for Additive Manufacturing					E53542		

Test Name	Test Method	Units	Thk (mm)	Value
Flammability	IEC 60695-11-10	Class (color)	3.0-3.3	V-0 (GY)
Glow-Wire Flammability (GWFI)	IEC 60695-2-12	°C	-	-
Glow-Wire Ignition (GWIT)	IEC 60695-2-13	°C	(141)	-
IEC Comparative Tracking Index	IEC 60112	Volts (Max)	-	-
IEC AC Dielectric Strength (AC DS)	IEC 60243-1	kV/mm	-	-
IEC DC Dielectric Strength (DC DS)	IEC 60243-2	kV/mm	5762	
IEC Volume Resistivity (VR)	IEC 62631-3-1	10 ^x ohm-m	-	.
IEC Surface Resistivity (SR)	IEC 62631-3-2	10 ^x ohms	(141)	¥.
IEC Inclined Plane Tracking (IPT)	IEC 60587	kV	220	2
IEC Ball Pressure	IEC 60695-10-2	°C	(14))	-
ISO Heat Deflection (1.80 MPa)	ISO 75-2	°C		-
ISO Tensile Strength	ISO 527-2	MPa	-	-
ISO Flexural Strength	ISO 178	MPa	-	-
ISO Tensile Impact	ISO 8256	kJ/m ²	-	-
ISO Izod Impact	ISO 180	kJ/m ²	(1 2))	¥.
ISO Charpy Impact	ISO 179-1	kJ/m ²	820	

Printing

Printing Parameters

Printer	Sonic Mini / Sonic Mini 4K
Layer Height	50 µm
Exposure Time	1.5–2 s
Bottom Exposure Time	30–40 s
Light-off Delay	12 s
Lift Distance	6 mm
Lifting Speed	60 mm/min

Printer	Sonic Mini 8K
Layer Height	50 µm
Exposure Time	2.5–3 s
Bottom Exposure Time	30–40 s
Rest Time After Retract	3 s
Lift Distance	6 mm
Lifting Speed	60 mm/min

Printer	Sonic Mini 8K S
Layer Height	50 µm
Exposure Time	1.5–2 s
Bottom Exposure Time	10–15 s
Rest Time After Retract	3 s
Lift Distance	6 mm
Lifting Speed	60 mm/min



Printer	Sonic Mighty 4K
Layer Height	50 µm
Exposure Time	2.5–3 s
Bottom Exposure Time	30–40 s
Light-off Delay	12 s
Lift Distance	8 mm
Lifting Speed	60 mm/min

Printer	Sonic Mighty 8K
Layer Height	50 µm
Exposure Time	2.5–3 s
Bottom Exposure Time	30–40 s
Rest Time After Retract	3 s
Lift Distance	8 mm
Lifting Speed	60 mm/min

Printer	Sonic Mighty 12K (Upgrade Kit)
Layer Height	50 µm
Exposure Time	2.5–3 s
Bottom Exposure Time	30–40 s
Rest Time After Retract	3 s
Lift Distance	8 mm
Lifting Speed	60 mm/min



Printer	Sonic Mega 8K*
Layer Height	50 µm
Exposure Time	30–40 s
Bottom Exposure Time	2.5–3.5 s
Rest Time After Retract	3 s
Lift Distance	8 mm
Lifting Speed	45 mm/min

Printer	Sonic Mega 8K S
Layer Height	50 µm
Exposure Time	15–20 s
Bottom Exposure Time	1.5–2 s
Rest Time After Retract	3 s
Lift Distance	8 mm
Lifting Speed	60 mm/min

* Mega 8K has a higher peeling force. Therefore, a longer exposure time is necessary to increase the success rate.

* Be sure to cover the hood when printing to maintain the best printing condition of the resin.



Cleaning

- After removing the printed object from the building stage, use the Phrozen Wash and Cure Kit for post-processing.
- Soak the object in Phrozen Washing Station filled with 95% alcohol for 45–60 seconds to remove uncured resin from the surface. Do not soak models for more than 60 seconds in alcohol (or other solvent such as IPA), as it may damage the surfaces.
- 3. Make sure to clean the inner parts of hollow objects completely.
- 4. After the object has been thoroughly cleaned, leave it in a cool, well-ventilated place for at least 30 minutes without exposure to light. Alternatively, you may gently apply compressed air to dry the printed object.

*When printing flat on the building plate, remove the printed objects carefully to avoid deformation on the objects.

Post-Curing

 Use Phrozen post-curing equipment (Phrozen Curing Station/Phrozen Cure/ Phrozen Mega Cure) or other post-curing lamps with the same wavelength to cure printed objects for 30–60 minutes for the best results.

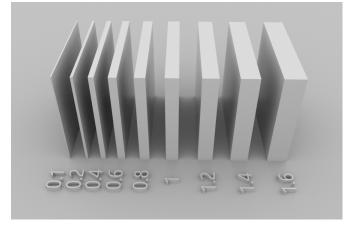
Design Specifications

% Note: All indicators are limited to each resin; the value will vary with different machines and environmental conditions.%

Minimum Unsupported Wall Thickness

This indicator shows the minimum wall thickness that can be printed independently with no support without causing any bending or breaking.

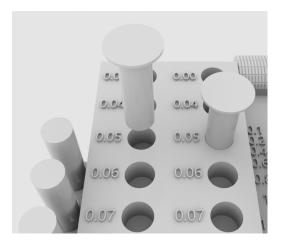
Recommended thickness: ≥ 0.4 mm



Size Tolerance, X-Y plane

This indicator shows the minimum dimensional tolerance between the hole and the column parallel to the XY plane.

Recommended tolerance: ≥ 0.2 mm

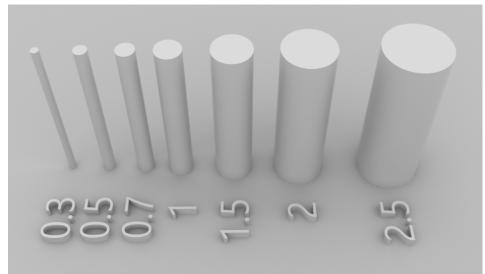




Minimum Pin Diameter

This indicator shows the minimum column diameter of pillars and supports that can be printed independently without bending or breaking.

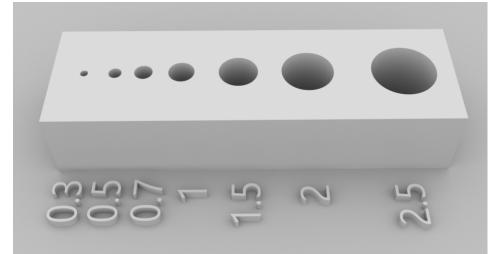
Recommended diameter: ≥ 0.7 mm



Minimum Hole Diameter, X-Y plane

This indicator shows the minimum hole diameter that can be successfully printed parallel to the XY plane.

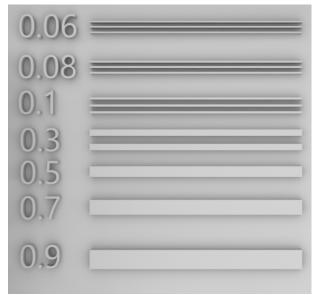
Recommended diameter: ≥ 1 mm





Minimum Embossed Detail Width, X-Y plane

This indicator shows the minimum line width that can successfully be printed with embossed details.

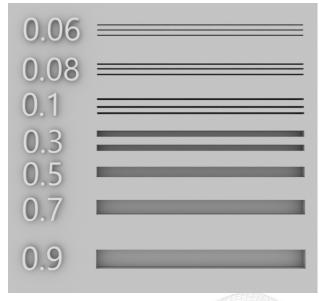


Recommended width: ≥ 0.1 mm

Minimum Engraved Detail Width, X-Y plane

This indicator shows the minimum line width that can successfully be printed with engraved details.

Recommended width: ≥ 0.5 mm





Maximum Horizontal Bridge Span

This indicator shows the maximum width between the supporting walls that can be printed without deforming the bridge.

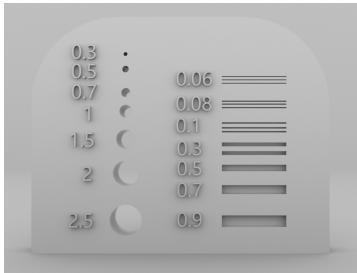
Recommended width: ≤ 6 mm



Minimum Hole Diameter and Engraved Detail Width, Z-Axis, at 0.05mm Layer Height

This indicator shows the minimum hole diameter and engraving groove width that can be successfully printed on the Z-axis with a layer thickness of 0.05mm.

Recommended diameter. ≥ 0.7 mm Recommended width: ≥ 0.3 mm





Applications